

DRD2050X34

Rectifier Diode

DS6010-1 March 2011 (LN28197)

FEATURES

- Double Side Cooling
- High Surge Capability

KEY PARAMETERS

 $\begin{array}{ll} V_{RRM} & 3400V \\ I_{F(AV)} & 2050A \\ I_{FSM} & 25800A \end{array}$

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{RRM} V	Conditions
DRD2050X34 DRD2050X32 DRD2050X30 DRD2050X28 DRD2050X26 DRD2050X24	3400 3200 3000 2800 2600 2400	$V_{RSM} = V_{RRM} + 100V$

(See Package Details for further information)

Fig. 1 Package outline

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DRD2050X34 for a 3400V device

CURRENT RATINGS

T_{case} = 75°C unless stated otherwise

Symbol	Parameter	Test Conditions		Units			
Double Si	Double Side Cooled						
I _{F(AV)}	Mean forward current	Half wave resistive load	2470	А			
I _{F(RMS)}	RMS value	-	3880	А			
I _F	Continuous (direct) on-state current	-	3490	А			

T_{case} = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
I _{F(AV)}	Mean forward current	Half wave resistive load	2050	А			
I _{F(RMS)}	RMS value	-	3220	А			
I _F	Continuous (direct) on-state current	-	2900	А			

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 175°C	25.8	kA
l ² t	I ² t for fusing	$V_R = 0$	3.33	MA ² s

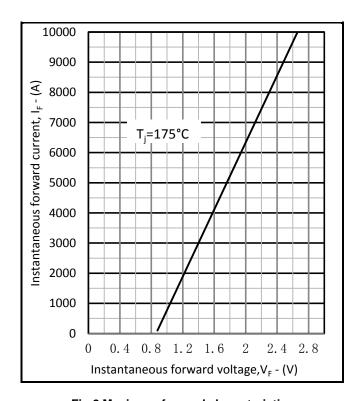
THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	3	Min.	Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC		0.018	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Double side cooled	DC	-	0.005	°C/W
T _{vj}	Virtual junction temperature	Blocking V _{DRM} / _{VRRM}		-40	175	°C
T _{stg}	Storage temperature range			-40	175	°C
F _m	Clamping force			26	34	kN

CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V _{FM}	Forward voltage	At 3000A peak, T _{case} = 25°C	-	1.55	V
I _{RM}	Peak reverse current	At V _{DRM} , T _{case} = 175°C	-	150	mA
Q _S	Total stored charge	I _F = 2000A, dI _{RR} /dt =10A/μs	-	5000	μC
		$T_{case} = 175^{\circ}C, V_{R} = 100V$			
V _{TO}	Threshold voltage	At T _{vj} = 175°C	-	0.86	V
r _T	Slope resistance	At T _{vj} = 175°C	-	0.18	mΩ

CURVES



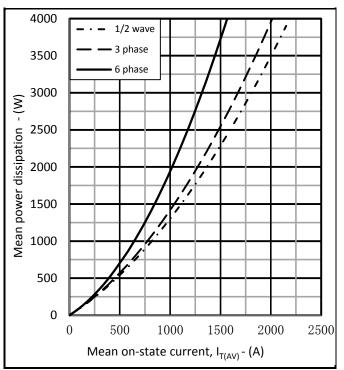
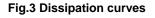


Fig.2 Maximum forward characteristics



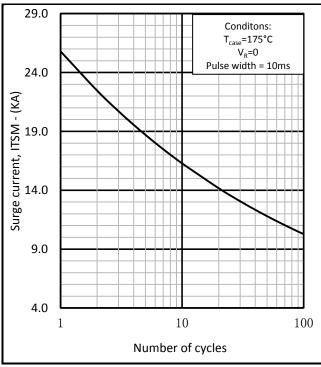


Fig.4 Surge (Non-Repetitive) Forward current vs time

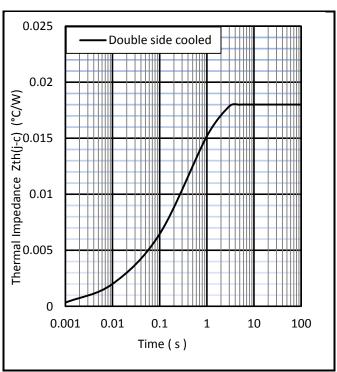
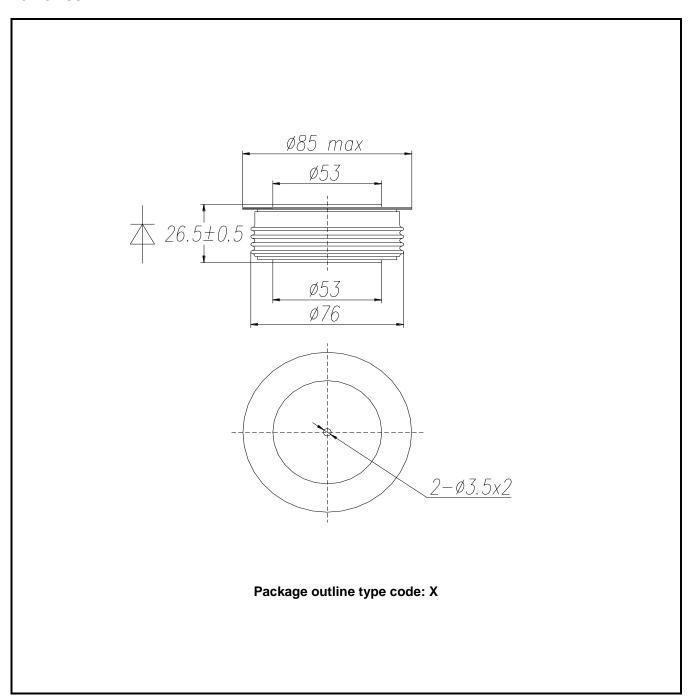


Fig.5 Maximum (limit) transient thermal impedancejunction to case

PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Note:

Some packages may be supplied with gate and or tags.

5/6 www.dynexsemi.com

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